

## GEMOLOGICAL INSTITUTE

### **ELECTRONIC COPY**

#### LABORATORY GROWN DIAMOND REPORT

May 15, 2023	
IGI Report Number	LG581330667
Description	LABORATORY GROWN DIAMOND
Shape and Cutting Style	ROUND BRILLIANT
Measurements	6.80 - 6.86 X 4.26 MM
GRADING RESULTS	
Carat Weight	1.24 CARAT
Color Grade	CION AND INF
Clarity Grade	VVS 1
Cut Grade	IDEAL
ADDITIONAL GRADING INFORMA	TION
Polish	EXCELLENT
Symmetry	EXCELLENT

Fluorescence	NONE		
Inscription(s)	1G1 LG581330667		

Comments: As Grown - No indication of post-growth treatment.

This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process. Type II

#### LABORATORY GROWN DIAMOND REPORT

LG581330667 Report verification at igi.org

57%

Pointed

35.6°

40.6°

62.3%

PROPORTIONS

15.5%

43%

**CLARITY CHARACTERISTICS** 

**KEY TO SYMBOLS** 

Red symbols indicate internal characteristics.

Green symbols indicate external characteristics.

 $\checkmark$ 

Medium To

Slightly Thick (Faceted)

#### LABORATORY GROWN DIAMOND REPORT

#### **GRADING SCALES**

#### CLARITY

IF	VVS <sup>1-2</sup>	VS <sup>1-2</sup>	SI <sup>1-2</sup>	l <sup>1-3</sup>
Internally	Very Very	Very	Slightly	Included
Flawless	Slightly Included	Slightly Included	Included	

#### COLOR

D	Е	F	G	Н	I	J	Faint	Very Light	Light
								, ,	

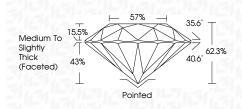


Sample Image Used

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#### ADDITIONAL GRADING INFORMATION

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THIS DOCUMENT WAS PRODUCED WITH THE FOLLOWING SECURITY MEASURES: SPECIAL DOCUMENT PAPER, INK SCREENS, WATERMARK BACKGROUND DESIGNS, HOLOGRAM AND OTHER SECURITY FRATURES NOT LISTED AND DO PICEED DOCUMENT SECURITY INDUSTRY GUIDELINES.

